

## Eytu project

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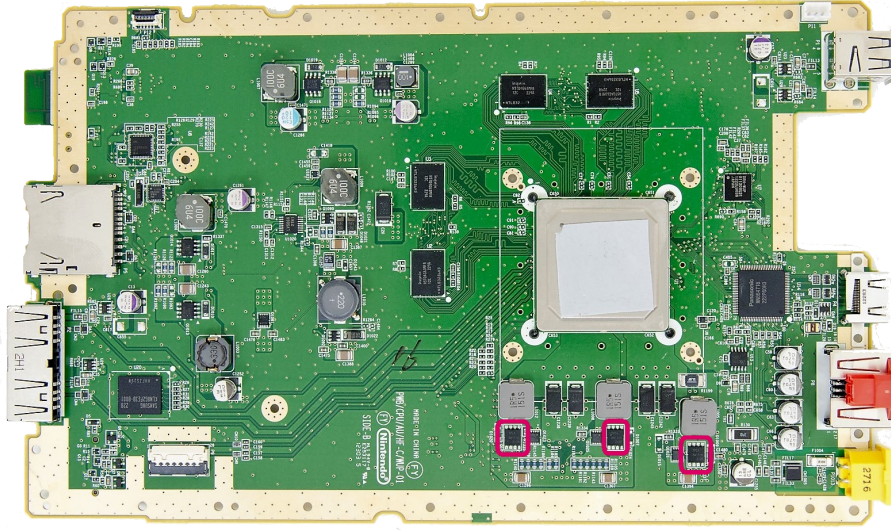


Figure 1: Motherboard front part (power section)

## 1. Power supply

### 1.1 Wii U main console

On the Wii U motherboard there is a discrete number of components involved in the power supply section, there are both passive components, discrete semiconductors and Integrated circuits all working together to power the PCB. In Figure 3 we summarized the main components listed under type and name: we can see the huge amount of passive components needed to support the integrated circuits and the discrete amount of transistors and diodes; on the other hand the number of integrated circuit is restrained.

In figure Figure 1 a photo of the motherboard section regarding the power supply is shown: the red squares represent three N-channel MOSFET, used to minimize losses in power conversion. Since one of their applications is for a rectifier in DC/DC converters, we suppose they are part of the power supply system in the board [1].

#### 1.1.1 Integrated circuits description

The three main integrated components that are worth to be described are:

- *The power management IC*, model TPS65070RSL from Texas Instruments;
- *The Regulator DC/DC Converter, Step-Up*, model AIC1634GG from Analog Integration corp.;
- *The switching Regulator DC/DC Controller, Step-Down*, model LV5066V from ON Semiconductors.

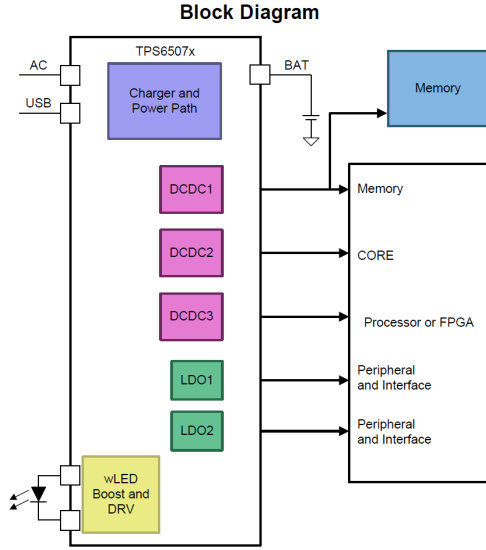


Figure 2: Schematic for TPS65070RSL

Component type	Name	Qty
Integrated circuit	Regulator	7
	Analog IC	5
	Voltage Detector	1
	Power Manag. IC	1
Discrete Semiconductor	Diode	30
	Transistor	35
Passive comp.	Capacitor	176
	Fuse	1
	Ferrite Bead	6
	Inductor	16
	Resistor	148

Figure 3: Power supply component list

**Control power IC TPS65070RSL** Is a single chip power solution for portable applications that can be powered through a USB port or directly by a DC voltage from a wall adapter connected to "AC" pin. The module has the following main characteristics:

- 2A output current on the power path;
- Thermal regulation;
- 3 Step-down converters
  - Fixed-frequency operation at 2.25 MHz;
  - Up to 1.5 A output current;
  - Adjustable or fixed output Voltage;
  - $2.8V < V_{IN} < 6.3V$
  - $19\mu A$  of quiescent current per converter;
  - 100% Duty cycle for lowest dropout;

A block diagram of the module is represented in figure Figure 2.

The two inputs to the power path (AC and USB) support the same voltage rating but normally have different current limits (Ac is at the higher limit). If voltage is applied at both inputs and both are enabled AC will be preferred over USB and the device will only be powered from AC. The current at the input is shared between charging the battery and powering the system load; anyway priority is given to the system load. The current is always monitored, so that if the sum of the charging and system load currents exceeds the present maximum input current the charging current is reduced automatically [2].

**The Regulator DC/DC Converter AIC1634GG** The module is a current-mode pulse-width modulation (PWM), step-up DC/DC Converter which, through the N-channel MOSFET, allows for step-up applications with up to 30V output voltage. The high switching frequency (1.4MHz) allows the use of small external components.

There are several characteristics that can be compared in the module, here we list just two comparisons as examples. The first chart (Figure 6), shows how the efficiency of the module varies with the evolution of the output current: it can be seen that its value rapidly saturates for low current values and starts decreasing beyond the 40 mA threshold. The second chart (Figure 7) describes the evolution of the switching frequency over the temperature: differently from the efficiency, the frequency continues to constantly grow with the temperature increase [3].

Figure 4 shows the block diagram for the module.

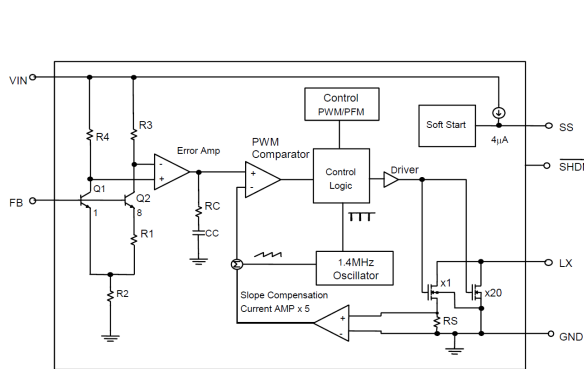


Figure 4: AIC1634GG block diagram

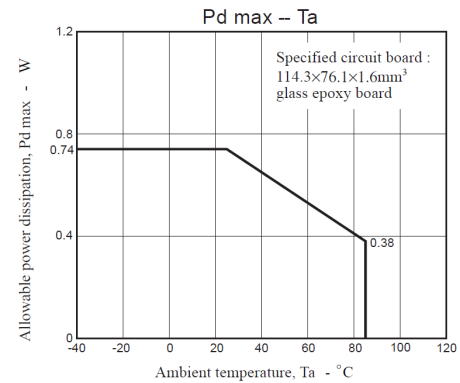


Figure 5: Power constraint over the ambient temperature

**The switching Regulator DC/DC Controller LV5066V** The last element of this analysis is a step-down switching regulator controller: it has one channel with an operation current of  $80\mu A$  and low power consumption. Also, from Figure 5 it can be observed the evolution of the allowable power dissipation depending on the ambient temperature: it can be seen how there is a clear power constraint, with a linear decrement of the latter during the interval representing the normal temperature range of a room.

## 1.2 Wii U gamepad

## References

- [1] *FDMS8026S N-Channel PowerTrench® SyncFET™*, Fairchild Semiconductors (Now ON Semiconductors), October 2014.

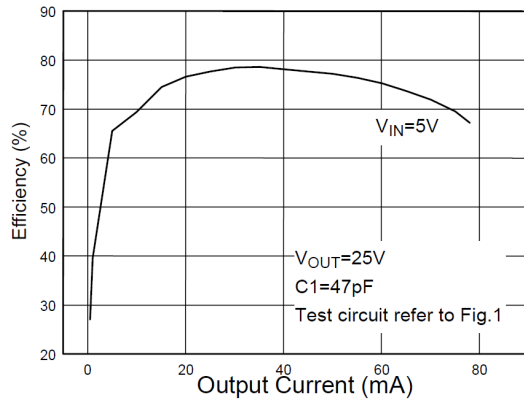


Fig. 9 Efficiency vs. Output Current

Figure 6

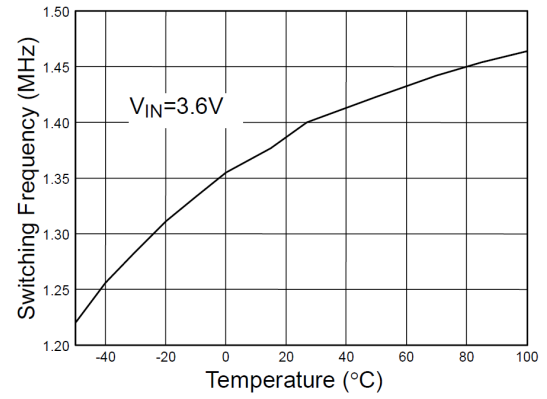


Fig. 10 Switching Frequency vs. Temperature

Figure 7

- [2] *TPS65070x Single Chip Power Solution for Battery Powered Systems*, Texas Instruments, September 2015, rev. 1.
- [3] *1.4MHz Current-Mode Step-Up DC/DC Converter*, aic (Analog Integration Corporation).